查询SN74ALVCH16901供应商

捷多邦,专业PCB打样工厂,24小时**分时但在**LVCH16901 18-BIT UNIVERSAL BUS TRANSCEIVER WITH PARITY GENERATORS/CHECKERS SCES010E – JULY 1995 – REVISED FEBRUARY 1999

| Member of the Texas Instruments Widebus+[™] Family | D | GG PACKA | |
|---|-------------------------------------|----------------|--|
| EPIC ™ (Enhanced-Performance Implanted CMOS) Submicron Process | 1CLKENAB [LEAB [| |] 1CLKENBA |
| UBT[™] (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, | CLKAB [1ERRA [1APAR] | 3 62 4 61 | CLKBA] CLKBA] 1ERRB] 1BPAR |
| Latched, or Clocked Mode Simultaneously Generates and Checks | GND [1A1 [| |] GND] 1B1 |
| Option to Select Generate Parity and Check | 1A2 [1A3 [| 9 56 |] 1B2] 1B3 |
| or Feed-Through Data/Parity in A-to-B or B-to-A Directions | V _{CC} [1A4 [1A5 [| 11 54 | V _{CC} 1B4 1B5 |
| ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0) | 1A6 [GND [| 13 52 14 51 |] 1B6] GND |
| Latch-Up Performance Exceeds 250 mA Per JESD 17 | 1A7 [1A8 [2A1 [| 16 49 |] 1B7] 1B8] 2B1 |
| Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors | 2A2 [GND [| 18 47 19 46 |] 2B2] GND |
| Packaged in Thin Shrink Small-Outline Package | 2A3 [2A4 [2A5 [| 21 44 |] 2B3] 2B4] 2B5 |
| description | V _{CC} [2A6 [| 23 42 | V _{CC} 2B6 |
| This 18-bit (dual-octal) noninverting registered transceiver is designed for 1.65-V to 3.6-V V _{CC} operation. | 2A8 [GND [| 26 39 27 38 | 2B7 2B8 GND |
| The SN74ALVCH16901 is a dual 9-bit to dual 9-bit parity transceiver with registers. The device can operate as a feed-through transceiver or it can | | 29 36 30 35 | 2BPAR 2ERRB OEBA |
| generate/check parity from the two 8-bit data | SEL [2CLKENAB [| - |] ODD/EVEN] 2CLKENBA |

The SN74ALVCH16901 features independent clock (CLKAB or CLKBA), latch-enable (LEAB or LEBA), and dual 9-bit clock-enable (CLKENAB or CLKENBA) inputs. It also provides parity-enable (SEL) and parity-select (ODD/EVEN) inputs and separate error-signal (ERRA or ERRB) outputs for checking parity. The direction of data flow is controlled by OEAB and OEBA. When SEL is low, the parity functions are enabled. When SEL is high, the parity functions are disabled and the device acts as an 18-bit registered transceiver.

To ensure the high-impedance state during power up or power down, OE should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH16901 is characterized for operation from -40°C to 85°C.



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buses in either direction.



Function Tables

| FUNCTION [†] |
|-----------------------|
|-----------------------|

| | INPUTS | | | | | | | | | |
|---------|--------|------|------------|---|------------------|--|--|--|--|--|
| CLKENAB | OEAB | LEAB | CLKAB | Α | В | | | | | |
| Х | Н | Х | Х | Х | Z | | | | | |
| Х | L | Н | Х | L | L | | | | | |
| Х | L | Н | Х | Н | н | | | | | |
| н | L | L | Х | Х | в ₀ ‡ | | | | | |
| L | L | L | \uparrow | L | L | | | | | |
| L | L | L | \uparrow | Н | Н | | | | | |
| L | L | L | L | Х | в ₀ ‡ | | | | | |
| L | L | L | Н | Х | в ₀ § | | | | | |

[†] A-to-B data flow is shown: B-to-A flow is similar, but uses OEBA, LEBA, and CLKENBA.

[‡] Output level before the indicated steady-state input conditions were established

 $\$ Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low

PARITY ENABLE

| | INPUTS | | OPERATION OR FUNCTION | | | | | |
|-----|--------|------|--|----------------------------------|--|--|--|--|
| SEL | OEBA | OEAB | OPERATION OF | FUNCTION | | | | |
| L | Н | L | Parity is checked on port A and is generated on port B. | | | | | |
| L | L | Н | Parity is checked on port B and is generated on port A. | | | | | |
| L | Н | Н | Parity is checked on port B and port A. | | | | | |
| L | L | L | Parity is generated on port A and B if device is in FF mode. | | | | | |
| н | L | L | | Q_A data to B, Q_B data to A | | | | |
| н | L | Н | Parity functions are disabled; device acts as a standard | Q _B data to A | | | | |
| н | Н | L | 18-bit registered transceiver. | Q _A data to B | | | | |
| н | Н | Н | | Isolation | | | | |



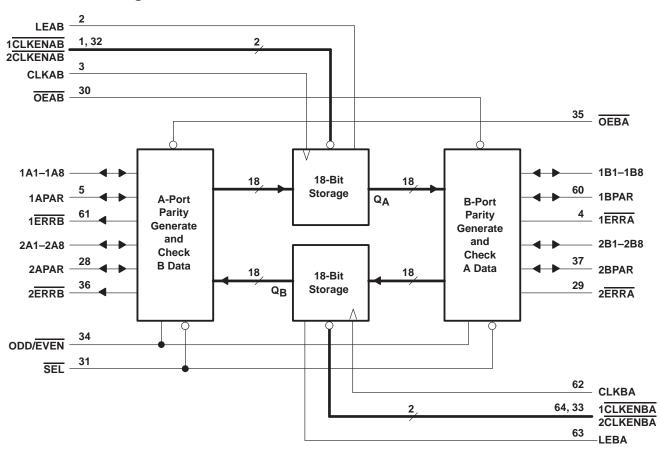
| | | | | | PARITY | | | _ | | | |
|-----|------|------|----------|--------------------------|--------------------------|------|------|-----------------|------|------|------|
| | | | | INPUTS | | | | | OUTI | PUTS | |
| SEL | OEBA | OEAB | ODD/EVEN | Σ OF INPUTS A1–A8 = H | Σ OF INPUTS B1–B8 = H | APAR | BPAR | APAR | ERRA | BPAR | ERRB |
| L | Н | L | L | 0, 2, 4, 6, 8 | N/A | L | N/A | N/A | Н | L | Z |
| L | Н | L | L | 1, 3, 5, 7 | N/A | L | N/A | N/A | L | Н | Z |
| L | Н | L | L | 0, 2, 4, 6, 8 | N/A | Н | N/A | N/A | L | L | Z |
| L | Н | L | L | 1, 3, 5, 7 | N/A | Н | N/A | N/A | Н | Н | Z |
| L | L | Н | L | N/A | 0, 2, 4, 6, 8 | N/A | L | L | Z | N/A | Н |
| L | L | Н | L | N/A | 1, 3, 5, 7 | N/A | L | н | Z | N/A | L |
| L | L | Н | L | N/A | 0, 2, 4, 6, 8 | N/A | Н | L | Z | N/A | L |
| L | L | Н | L | N/A | 1, 3, 5, 7 | N/A | Н | н | Z | N/A | н |
| L | Н | L | Н | 0, 2, 4, 6, 8 | N/A | L | N/A | N/A | L | Н | Z |
| L | Н | L | Н | 1, 3, 5, 7 | N/A | L | N/A | N/A | Н | L | Z |
| L | Н | L | Н | 0, 2, 4, 6, 8 | N/A | Н | N/A | N/A | Н | Н | Z |
| L | Н | L | Н | 1, 3, 5, 7 | N/A | Н | N/A | N/A | L | L | Z |
| L | L | Н | Н | N/A | 0, 2, 4, 6, 8 | N/A | L | н | Z | N/A | L |
| L | L | Н | Н | N/A | 1, 3, 5, 7 | N/A | L | L | Z | N/A | н |
| L | L | Н | Н | N/A | 0, 2, 4, 6, 8 | N/A | Н | н | Z | N/A | н |
| L | L | Н | Н | N/A | 1, 3, 5, 7 | N/A | Н | L | Z | N/A | L |
| L | Н | Н | L | 0, 2, 4, 6, 8 | 0, 2, 4, 6, 8 | L | L | Z | Н | Z | Н |
| L | Н | Н | L | 1, 3, 5, 7 | 1, 3, 5, 7 | L | L | Z | L | Z | L |
| L | Н | Н | L | 0, 2, 4, 6, 8 | 0, 2, 4, 6, 8 | Н | Н | Z | L | Z | L |
| L | Н | Н | L | 1, 3, 5, 7 | 1, 3, 5, 7 | Н | Н | Z | Н | Z | н |
| L | Н | Н | Н | 0, 2, 4, 6, 8 | 0, 2, 4, 6, 8 | L | L | Z | L | Z | L |
| L | Н | Н | Н | 1, 3, 5, 7 | 1, 3, 5, 7 | L | L | z | Н | Z | н |
| L | Н | Н | Н | 0, 2, 4, 6, 8 | 0, 2, 4, 6, 8 | Н | Н | z | Н | Z | н |
| L | Н | Н | Н | 1, 3, 5, 7 | 1, 3, 5, 7 | Н | Н | Z | L | Z | L |
| L | L | L | L | N/A | N/A | N/A | N/A | PE [†] | Z | PE† | Z |
| L | L | L | Н | N/A | N/A | N/A | N/A | PO‡ | Z | PO‡ | Z |

Function Tables (Continued)

[†] Parity output is set to the level so that the specific bus side is set to even parity.

[‡] Parity output is set to the level so that the specific bus side is set to odd parity.

functional block diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| Input voltage range Output voltage range Input clamp current Output clamp current Continuous output Continuous current Package thermal in | ge, V_O (see Notes 1 and 2) t, I_{IK} ($V_I < 0$) ent, I_{OK} ($V_O < 0$) current, I_O through each V_{CC} or GND npedance, θ_{JA} (see Note 3) | $\begin{array}{c} -0.5 \ \mbox{V to } 4.6 \ \mbox{V} \\ -0.5 \ \mbox{V to } \ \mbox{V}_{CC} + 0.5 \ \mbox{V} \\ -0.5 \ \mbox{V to } \ \mbox{V}_{CC} + 0.5 \ \mbox{V} \\ -50 \ \mbox{mA} \\ \pm 50 \ \mbox{mA} \\ \pm 100 \ \mbox{mA} \\ 73^{\circ}\ \mbox{C/W} \end{array}$ |
|---|---|---|
| | | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed...

2. This value is limited to 4.6 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51.



| recommended | operating | conditions | (see Note 4) |
|-------------|-----------|------------|--------------|
|-------------|-----------|------------|--------------|

| | | | MIN | MAX | UNIT | |
|---------------------|------------------------------------|------------------------------------|--|----------------------|------|--|
| Vcc | Supply voltage | | 1.65 | 3.6 | V | |
| | | V _{CC} = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ | | | |
| VIH | High-level input voltage | V _{CC} = 2.3 V to 2.7 V | 1.7 | | V | |
| | | V _{CC} = 2.7 V to 3.6 V | 2 | | | |
| | | V _{CC} = 1.65 V to 1.95 V | | $0.35 \times V_{CC}$ | | |
| VIL | Low-level input voltage | V_{CC} = 2.3 V to 2.7 V | V 0.35 × V _{CC} 0.7 0.8 0 V _{CC} 0 V _{CC} -4 -4 | V | | |
| | | V _{CC} = 2.7 V to 3.6 V | | 0.8 | | |
| VI | Input voltage | - | 0 | VCC | V | |
| Vo | Output voltage | | 0 | VCC | V | |
| | | V _{CC} = 1.65 V | | -4 | - mA | |
| 1 | Lich loud output outpot | V _{CC} = 2.3 V | | -12 | | |
| ЮН | High-level output current | V _{CC} = 2.7 V | | -12 | | |
| | | V _{CC} = 3 V | | -24 | | |
| | | V _{CC} = 1.65 V | | 4 | | |
| 1 | | V _{CC} = 2.3 V | | 12 | | |
| IOL | Low-level output current | V _{CC} = 2.7 V | | 12 | mA | |
| | V _{CC} = 3 V | | | 24 | | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | - | | 10 | ns/V | |
| TA | Operating free-air temperature | | -40 | 85 | °C | |

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAM | IETER | TEST C | ONDITIONS | Vcc | MIN | TYP† | MAX | UNIT | |
|--|---|---|--|-----------------|---------------------|------|------|------|--|
| | | I _{OH} = -100 μA | | 1.65 V to 3.6 V | V _{CC} -0. | 2 | | | |
| VOL II II IOZ [§] ICC ΔICC Ci Control inputs | | $I_{OH} = -4 \text{ mA}$ | | 1.65 V | 1.2 | | | | |
| | I _{OH} = -6 mA | | 2.3 V | 2 | | | | | |
| VOH | ′он ′оL I I(hold) OZ [§] | | | 2.3 V | 1.7 | | | V | |
| | | I _{OH} = -12 mA | | 2.7 V | 2.2 | | | | |
| | | | | 3 V | 2.4 | | | | |
| | | I _{OH} = -24 mA | | 3 V | 2 | | | | |
| | | I _{OL} = 100 μA | | 1.65 V to 3.6 V | | | 0.2 | | |
| | | I _{OL} = 4 mA | | 1.65 V | | | 0.45 | | |
| Mar | | IOL = 6 mA | | 2.3 V | | | 0.4 | V | |
| VOL | | 1. 10 mA | | 2.3 V | | | 0.7 | v | |
| | | I _{OL} = 12 mA | | 2.7 V | | | 0.4 | | |
| | | I _{OL} = 24 mA | | 3 V | | | 0.55 | | |
| Ц | | $V_{I} = V_{CC}$ or GND | | 3.6 V | | | ±5 | μA | |
| | | VI = 0.58 V | | 1.65 V | 25 | | | | |
| | | V _I = 1.07 V | | 1.65 V | -25 | | | | |
| | | V _I = 0.7 V | | 2.3 V | 45 | | | | |
| II(hold) | | V _I = 1.7 V | | 2.3 V | -45 | | | μA | |
| | | V _I = 0.8 V | | 3 V | 75 | | | | |
| | | V _I = 2 V | | 3 V | -75 | | | | |
| | | $V_{I} = 0$ to 3.6 V [‡] | | 3.6 V | | | ±500 | | |
| IOZ§ | | V _O = V _{CC} or GND | | 3.6 V | | | ±10 | μA | |
| ICC | | $V_{I} = V_{CC}$ or GND, | I ^O = 0 | 3.6 V | | | 40 | μΑ | |
| ∆ICC | | One input at V _{CC} – 0.6 V, | Other inputs at V _{CC} or GND | 3 V to 3.6 V | | | 750 | μA | |
| | ontrol inputs | V _I = V _{CC} or GND | | 3.3 V | | 3 | | pF | |
| | or B ports | $V_{O} = V_{CC}$ or GND | | 3.3 V | | 7.5 | | pF | |
| | R ports | $V_{O} = V_{CC}$ or GND | | 3.3 V | | 6 | | pF | |

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. [‡] This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another. $\$ For I/O ports, the parameter IOZ includes the input leakage current.



timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

| | | | | 1.8 V | V _{CC} = ± 0. | 2.5 V 2 V | V _{CC} = | 2.7 V | ۷ _{CC} = ± 0.3 | | UNIT | |
|------------------------------------|------------|---|-----|-------|---------------------------|--------------|-------------------|-------|----------------------------|-----|------|--|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | |
| f _{clock} Clock frequency | | | | † | | 125 | | 125 | | 125 | MHz | |
| t _w Pulse duration | Pulse | CLK↑ | † | | 3 | | 3 | | 3 | | ns | |
| | duration | LE high | † | | 3 | | 3 | | 3 | | 115 | |
| | | A, APAR or B, BPAR before CLK1 | † | | 1.9 | | 2 | | 1.7 | | | |
| t _{su} | Setup time | CLKEN before CLK [↑] | † | | 2.1 | | 2.1 | | 1.7 | | ns | |
| | | A, APAR or B, BPAR before LE \downarrow | † | | 1.4 | | 1.3 | | 1.2 | | | |
| | | A, APAR or B, BPAR after CLK [↑] | † | | 0.4 | | 0.4 | | 0.5 | | | |
| t _h | Hold time | CLKEN after CLK1 | † | | 0.5 | | 0.5 | | 0.7 | | ns | |
| | | A, APAR or B, BPAR after LE \downarrow | † | | 0.9 | | 1.1 | | 0.9 | | | |

[†]This information was not available at the time of publication.



switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = | 1.8 V | ×CC = ± 0. | | V _{CC} = | 2.7 V | = ۷ _{CC} ± 0. | | UNI |
|------------------|-----------------|------------------------------------|-------------------|-------|---------------|------|-------------------|-------|---------------------------|-----|-----|
| | (INFOT) | (001P01) | MIN | TYP | MIN | MAX | MIN | MAX | MIN | MAX | |
| f _{max} | | | † | | 125 | | 125 | | 125 | | MHz |
| | A or B | B or A | | † | 1 | 5.2 | | 4.8 | 1 | 4.4 | |
| | AUB | BPAR or APAR | | † | 2 | 8.9 | | 7.6 | 2 | 6.7 | |
| | APAR or BPAR | BPAR or APAR | | † | 1 | 5.7 | | 5.2 | 1 | 4.7 | |
| | | ERRA or ERRB | | † | 2 | 9.7 | | 8.7 | 2 | 7.5 | |
| | ODD/EVEN | ERRA or ERRB | | † | 1.5 | 8.7 | | 7.9 | 1.5 | 6.8 | |
| | | BPAR or APAR | | † | 1.5 | 8.3 | | 7.6 | 1.5 | 6.5 | |
| | SEL | BPAR or APAR | | † | 1 | 6.1 | | 5.9 | 1 | 5.1 | |
| | | A or B | | † | 1 | 6.4 | | 5.8 | 1 | 5.1 | |
| ^t pd | CLKAB or CLKBA | BPAR or APAR parity feedthrough | | + | 1.5 | 7.1 | | 6.3 | 1.5 | 5.6 | ns |
| | | BPAR or APAR parity generated | | † | 2.5 | 10.2 | | 8.7 | 2 | 7.7 | |
| | | ERRA or ERRB | | † | 2.5 | 10.5 | | 8.9 | 2 | 7.9 | |
| | | A or B | | † | 1 | 6 | | 5.5 | 1 | 4.8 | |
| | | BPAR or APAR parity feedthrough | | † | 1.5 | 6.7 | | 6 | 1.5 | 5.3 | |
| | LEAB or LEBA | BPAR or APAR parity generated | | † | 2.5 | 9.8 | | 8.3 | 2 | 7.4 | |
| | | ERRA or ERRB | | † | 2.5 | 9.9 | | 8.5 | 2 | 7.5 | |
| t _{en} | OEAB or OEBA | B, BPAR or A, APAR | | † | 1.4 | 6.3 | | 6.1 | 1 | 5.3 | ns |
| ^t dis | OEAB or OEBA | B, BPAR or A, APAR | | † | 1.3 | 6.1 | | 5.2 | 1.5 | 4.9 | ns |
| ten | OEAB or OEBA | ERRA or ERRB | | † | 1.4 | 6.2 | | 5.5 | 1 | 4.9 | ns |
| ^t dis | OEAB or OEBA | ERRA or ERRB | | † | 1.3 | 7.3 | | 6.5 | 1 | 5.7 | ns |
| t _{en} | SEL | ERRA or ERRB | | † | 1.4 | 6.7 | | 6.5 | 1 | 5.5 | ns |
| tdis | SEL | ERRA or ERRB | | † | 1.3 | 6.4 | | 5.4 | 1.5 | 4.9 | ns |

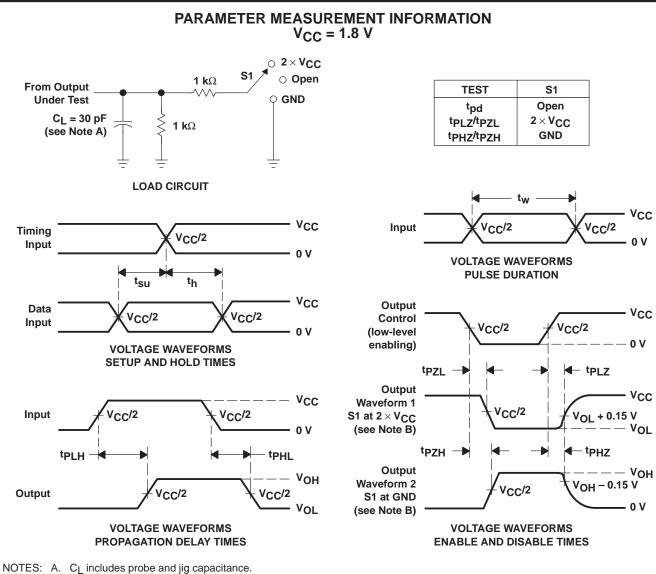
[†] This information was not available at the time of publication.

operating characteristics, $T_A = 25^{\circ}C$

| | PARAMETER | | TEST CONDITIONS | V _{CC} = 1.8 V TYP | V _{CC} = 2.5 V TYP | V _{CC} = 3.3 V TYP | UNIT |
|-----------------|-------------------|------------------|------------------------------------|--------------------------------|--------------------------------|--------------------------------|------|
| | Power dissipation | Outputs enabled | C ₁ = 50 pF. f = 10 MHz | † | 22 | 27 | ~F |
| C _{pd} | capacitance | Outputs disabled | C _L = 50 pF, f = 10 MHz | † | 5 | 8 | p⊦ |

[†] This information was not available at the time of publication.

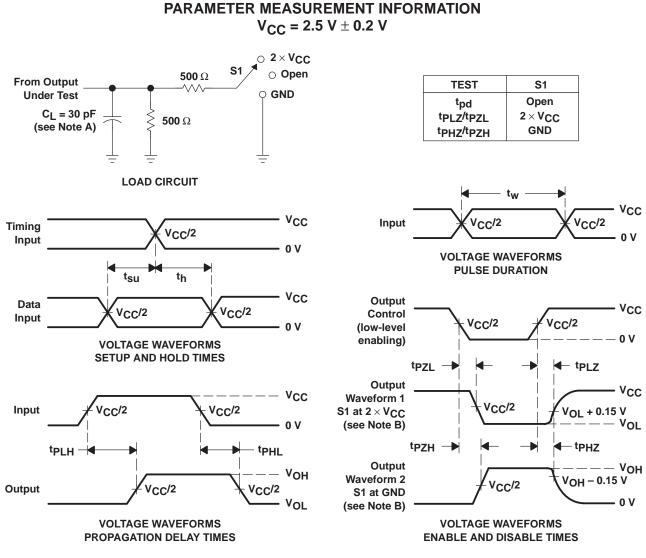




- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω , t_f \leq 2 ns, t_f \leq 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tPLZ and tPHZ are the same as tdis.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tpLH and tpHL are the same as tpd.

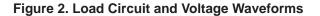
Figure 1. Load Circuit and Voltage Waveforms





NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω , t_f \leq 2 ns, t_f \leq 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tPLH and tPHL are the same as tpd.





PARAMETER MEASUREMENT INFORMATION V_{CC} = 2.7 V AND 3.3 V \pm 0.3 V ⊖ 6 V **S**1 TEST **S1** O Open **500** Ω From Output Open ^tpd GND \cap **Under Test** tPLZ/tPZL 6 V $C_L = 50 \text{ pF}$ tPHZ/tPZH GND **500** Ω (see Note A) tw LOAD CIRCUIT 2.7 V 1.5 V 1.5 V Input 2.7 V Timing 1.5 V 0 V Input 0 V **VOLTAGE WAVEFORMS** PULSE DURATION t_{su} th 2.7 V Data 1.5 V 1.5 V 2.7 V Output Input Control 0 V 1.5 V 1.5 V (low-level **VOLTAGE WAVEFORMS** enabling) - 0 V SETUP AND HOLD TIMES tPZL -^tPLZ Output 3 V 2.7 V Waveform 1 1.5 V Input 1.5 V 1.5 V S1 at 6 V V_{OL} + 0.3 V VOL (see Note B) 0 V ^tPHZ ^tPZH -^tPHL ^tPLH Output Уон VOH VOH - 0.3 V Waveform 2 1.5 V Output 1.5 V 1.5 V S1 at GND 0 V VOL (see Note B) **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES** ENABLE AND DISABLE TIMES

NOTES: A. C_L includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tPLH and tPHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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